

IRGIB10B60KD1

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

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	Parameter	Min.	Typ.	Max.	Units	Conditions
V _{(BR)CES}	Collector-to-Emitter Breakdown Voltage	600	—	—	V	V _{GE} = 0V, I _C = 500μA
ΔV _{(BR)CES} /ΔT _J	Temperature Coeff. of Breakdown Voltage	—	0.99	—	V/°C	V _{GE} = 0V, I _C = 1mA (25°C-150°C)
V _{CE(on)}	Collector-to-Emitter Voltage	1.50	1.70	2.10	V	I _C = 10A, V _{GE} = 15V, T _J = 25°C
		—	2.05	2.35		I _C = 10A, V _{GE} = 15V, T _J = 150°C
		—	2.06	2.35		I _C = 10A, V _{GE} = 15V, T _J = 175°C
V _{GE(th)}	Gate Threshold Voltage	3.5	4.5	5.5	V	V _{CE} = V _{GE} , I _C = 250μA
ΔV _{GE(th)} /ΔT _J	Threshold Voltage temp. coefficient	—	-10	—	mV/°C	V _{CE} = V _{GE} , I _C = 1mA (25°C-150°C)
g _{fe}	Forward Transconductance	—	5.0	—	S	V _{CE} = 50V, I _C = 10A, PW = 80μs
I _{CES}	Zero Gate Voltage Collector Current	—	1.0	150	μA	V _{GE} = 0V, V _{CE} = 600V
		—	90	250		V _{GE} = 0V, V _{CE} = 600V, T _J = 150°C
		—	150	400		V _{GE} = 0V, V _{CE} = 600V, T _J = 175°C
V _{FM}	Diode Forward Voltage Drop	—	1.80	2.40	V	I _F = 5.0A, V _{GE} = 0V
		—	1.32	1.74		I _F = 5.0A, V _{GE} = 0V, T _J = 150°C
		—	1.23	1.62		I _F = 5.0A, V _{GE} = 0V, T _J = 175°C
I _{GES}	Gate-to-Emitter Leakage Current	—	—	±100	nA	V _{GE} = ±20V, V _{CE} = 0V

Switching Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q _g	Total Gate Charge (turn-on)	—	41	62	nC	I _C = 10A V _{CC} = 400V V _{GE} = 15V
Q _{ge}	Gate-to-Emitter Charge (turn-on)	—	4.6	6.9		
Q _{gc}	Gate-to-Collector Charge (turn-on)	—	19	29		
E _{on}	Turn-On Switching Loss	—	156	264	μJ	I _C = 10A, V _{CC} = 400V V _{GE} = 15V, R _G = 50Ω, L = 1.07mH L _S = 150nH, T _J = 25°C
E _{off}	Turn-Off Switching Loss	—	165	273		
E _{tot}	Total Switching Loss	—	321	434		
t _{d(on)}	Turn-On delay time	—	25	33	ns	I _C = 10A, V _{CC} = 400V V _{GE} = 15V, R _G = 50Ω, L = 1.1mH L _S = 150nH, T _J = 25°C
t _r	Rise time	—	24	34		
t _{d(off)}	Turn-Off delay time	—	180	250		
t _f	Fall time	—	62	87	μJ	I _C = 10A, V _{CC} = 400V V _{GE} = 15V, R _G = 50Ω, L = 1.07mH L _S = 150nH, T _J = 150°C
E _{on}	Turn-On Switching Loss	—	261	372		
E _{off}	Turn-Off Switching Loss	—	313	425		
E _{tot}	Total Switching Loss	—	574	694	ns	I _C = 8.0A, V _{CC} = 400V V _{GE} = 15V, R _G = 50Ω, L = 1.07mH L _S = 150nH, T _J = 150°C
t _{d(on)}	Turn-On delay time	—	22	31		
t _r	Rise time	—	24	34		
t _{d(off)}	Turn-Off delay time	—	240	340	nH	Measured 5 mm from package
t _f	Fall time	—	48	67		
L _E	Internal Emitter Inductance	—	7.5	—		
C _{ies}	Input Capacitance	—	610	915	pF	V _{GE} = 0V V _{CC} = 30V f = 1.0MHz
C _{oes}	Output Capacitance	—	66	99		
C _{res}	Reverse Transfer Capacitance	—	23	35		
RBSOA	Reverse Bias Safe Operating Area	FULL SQUARE				T _J = 150°C, I _C = 32A, V _p = 600V V _{CC} = 500V, V _{GE} = +15V to 0V, R _G = 50Ω
SCSOA	Short Circuit Safe Operating Area	10	—	—	μs	T _J = 150°C, V _p = 600V, R _G = 50Ω V _{CC} = 360V, V _{GE} = +15V to 0V
I _{SC (PEAK)}	Peak Short Circuit Collector Current	—	100	—	A	
E _{rec}	Reverse Recovery Energy of the Diode	—	99	128	μJ	T _J = 150°C
t _{rr}	Diode Reverse Recovery Time	—	79	103	ns	V _{CC} = 400V, I _F = 10A, L = 1.07mH
I _{rr}	Peak Reverse Recovery Current	—	14	18	A	V _{GE} = 15V, R _G = 50Ω
Q _{rr}	Diode Reverse Recovery Charge	—	553	719	nC	di/dt = 500A/μs

① V_{CC} = 80% (V_{CES}), V_{GE} = 20V, L = 100μH, R_G = 50Ω.

② Energy losses include "tail" and diode reverse recovery.

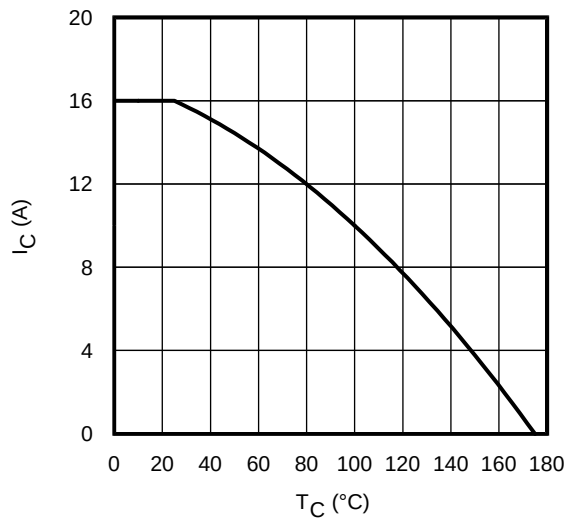


Fig. 1 - Maximum DC Collector Current vs. Case Temperature

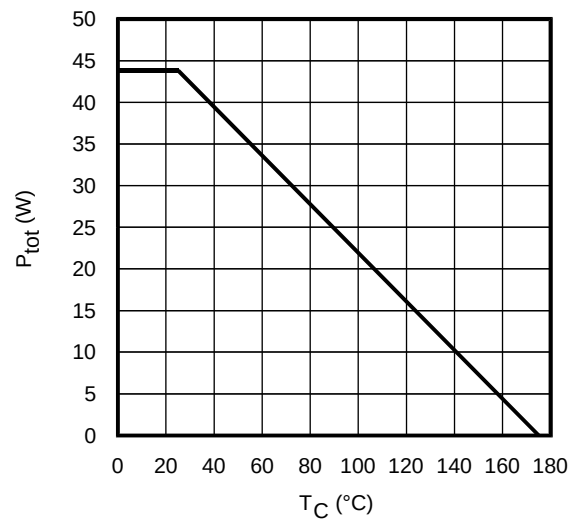


Fig. 2 - Power Dissipation vs. Case Temperature

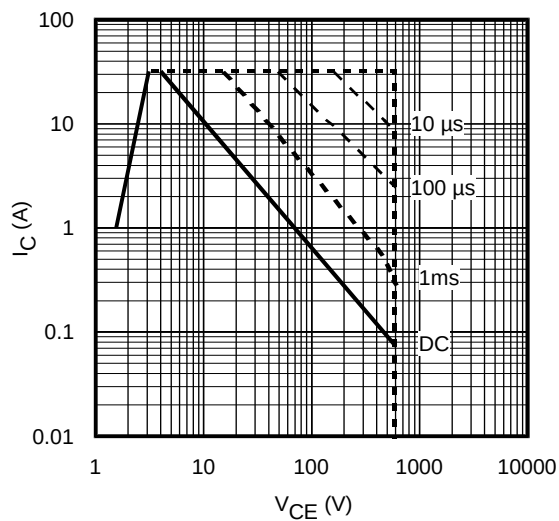


Fig. 3 - Forward SOA
 $T_C = 25^\circ\text{C}$; $T_J \leq 175^\circ\text{C}$

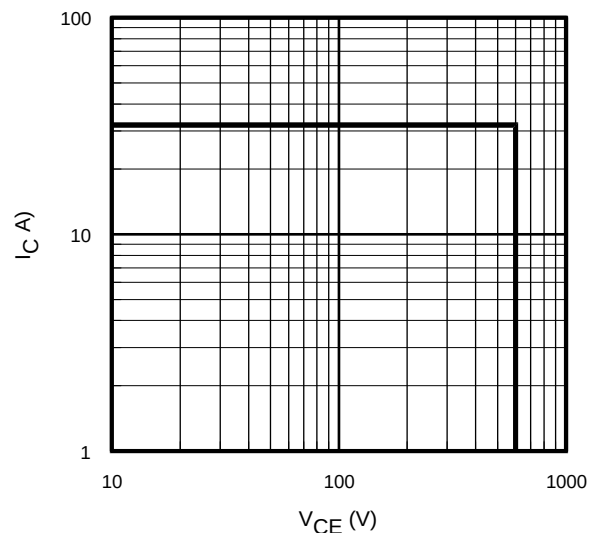


Fig. 4 - Reverse Bias SOA
 $T_J = 150^\circ\text{C}$; $V_{GE} = 15\text{V}$

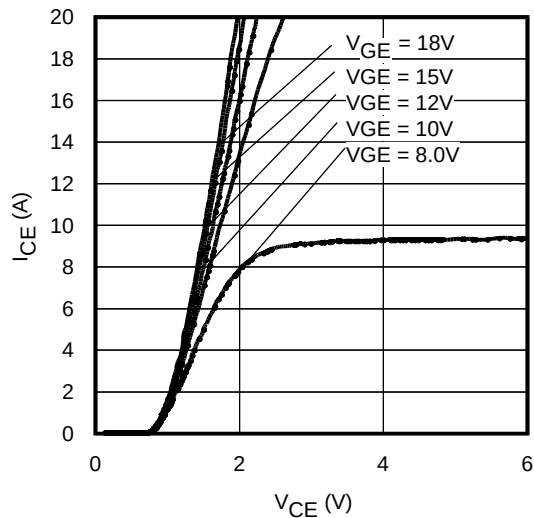


Fig. 5 - Typ. IGBT Output Characteristics
 $T_J = -40^\circ\text{C}$; $t_p = 80\mu\text{s}$

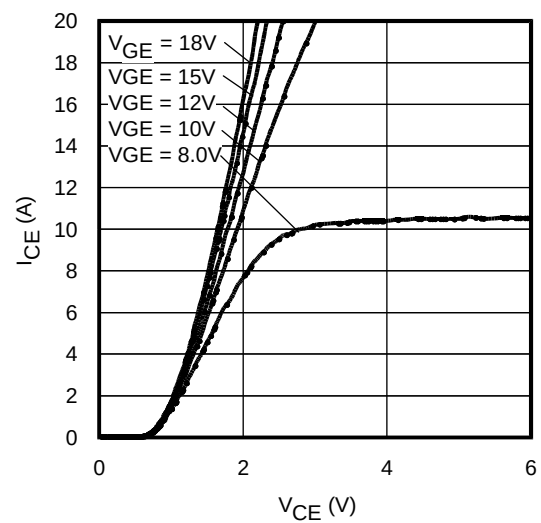


Fig. 6 - Typ. IGBT Output Characteristics
 $T_J = 25^\circ\text{C}$; $t_p = 80\mu\text{s}$

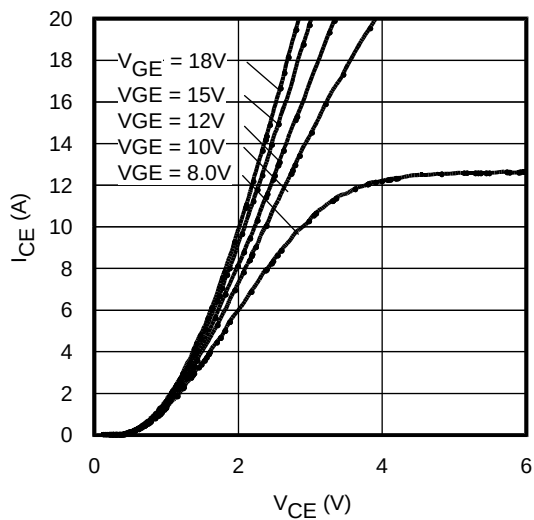


Fig. 7 - Typ. IGBT Output Characteristics
 $T_J = 150^\circ\text{C}$; $t_p = 80\mu\text{s}$

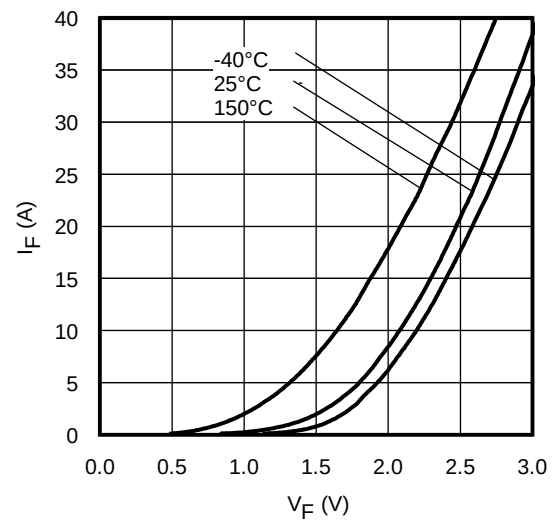


Fig. 8 - Typ. Diode Forward Characteristics
 $t_p = 80\mu\text{s}$

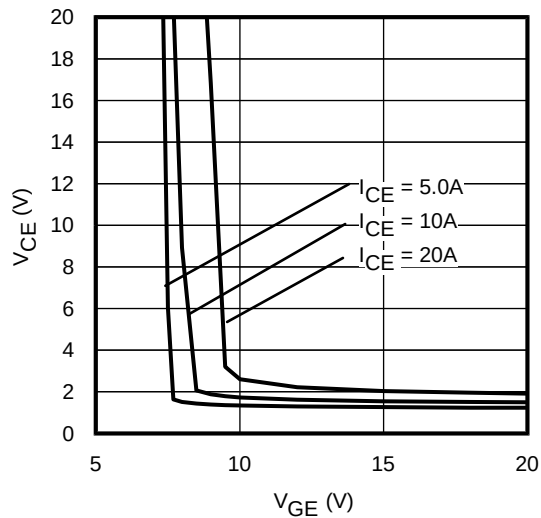


Fig. 9 - Typical V_{CE} vs. V_{GE}
 $T_J = -40^\circ\text{C}$

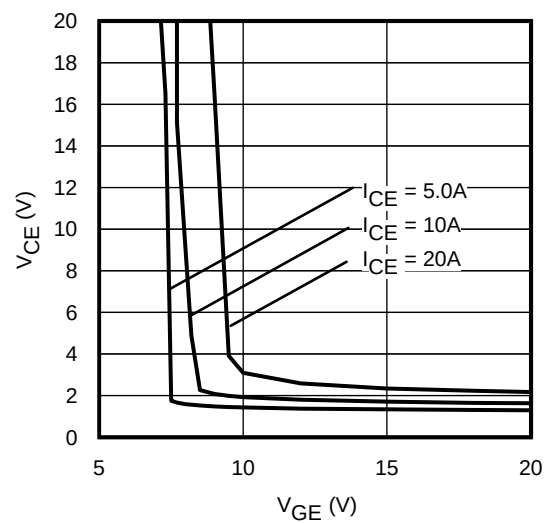


Fig. 10 - Typical V_{CE} vs. V_{GE}
 $T_J = 25^\circ\text{C}$

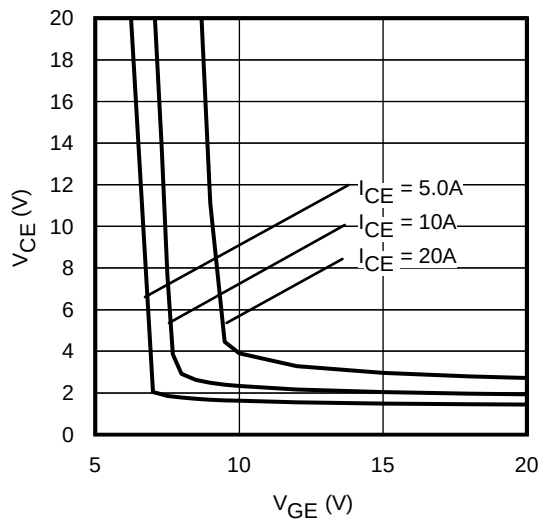


Fig. 11 - Typical V_{CE} vs. V_{GE}
 $T_J = 150^\circ\text{C}$

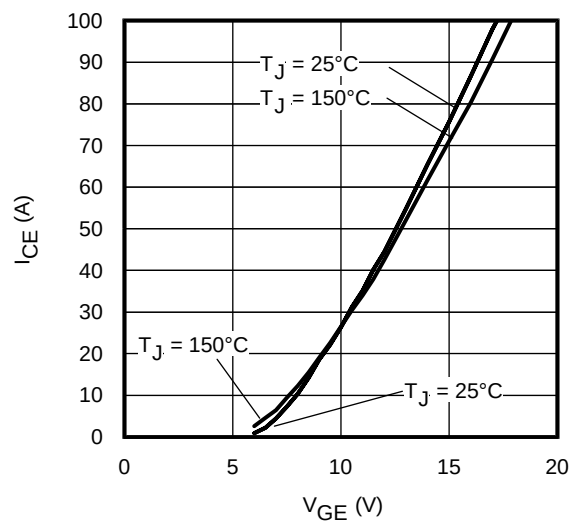


Fig. 12 - Typ. Transfer Characteristics
 $V_{CE} = 50\text{V}$; $t_p = 10\mu\text{s}$

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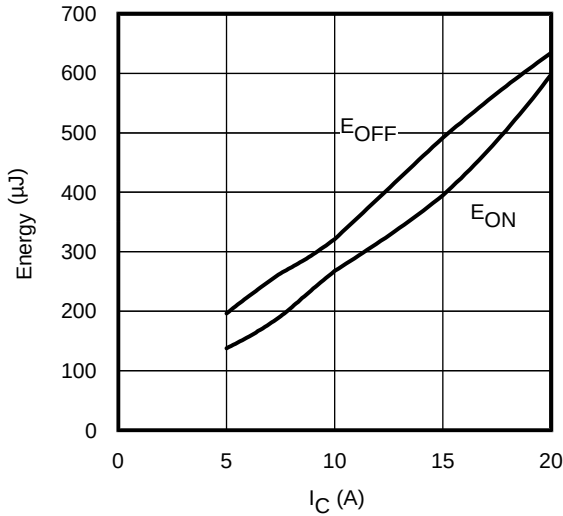


Fig. 13 - Typ. Energy Loss vs. I_C
 $T_J = 150^\circ\text{C}$; $L = 1.07\text{mH}$; $V_{CE} = 400\text{V}$
 $R_G = 50\Omega$; $V_{GE} = 15\text{V}$

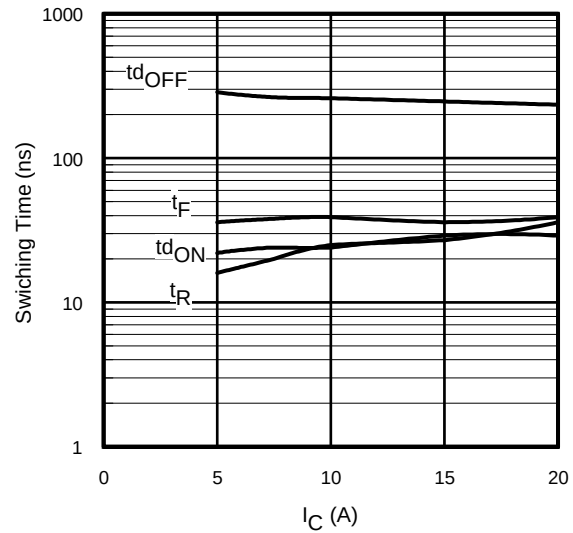


Fig. 14 - Typ. Switching Time vs. I_C
 $T_J = 150^\circ\text{C}$; $L = 1.07\text{mH}$; $V_{CE} = 400\text{V}$
 $R_G = 50\Omega$; $V_{GE} = 15\text{V}$

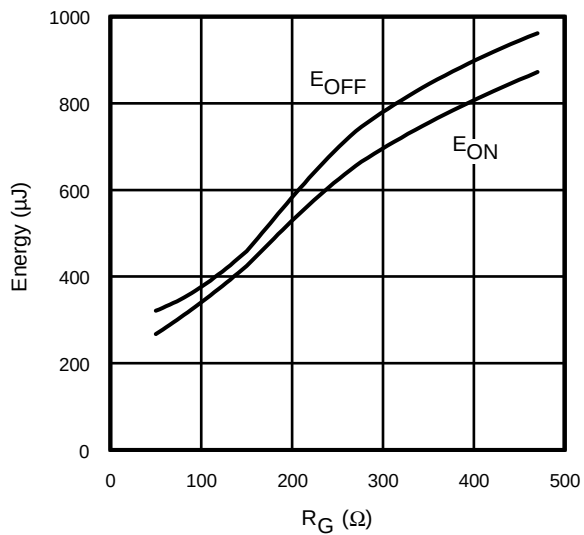


Fig. 15 - Typ. Energy Loss vs. R_G
 $T_J = 150^\circ\text{C}$; $L = 1.07\text{mH}$; $V_{CE} = 400\text{V}$
 $I_{CE} = 10\text{A}$; $V_{GE} = 15\text{V}$

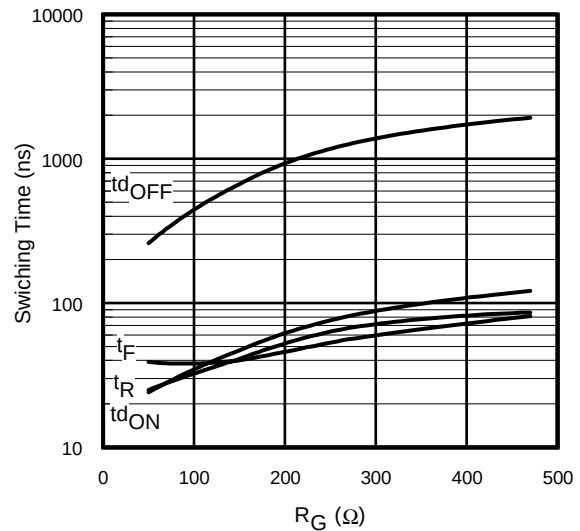


Fig. 16 - Typ. Switching Time vs. R_G
 $T_J = 150^\circ\text{C}$; $L = 1.07\text{mH}$; $V_{CE} = 400\text{V}$
 $I_{CE} = 10\text{A}$; $V_{GE} = 15\text{V}$

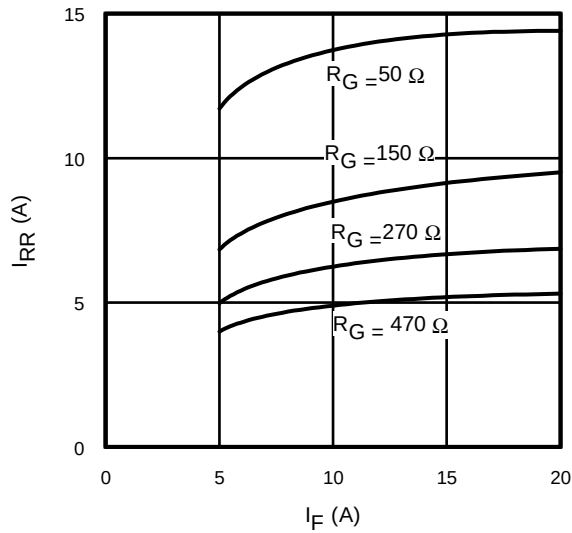


Fig. 17 - Typical Diode I_{RR} vs. I_F
 $T_J = 150^\circ\text{C}$

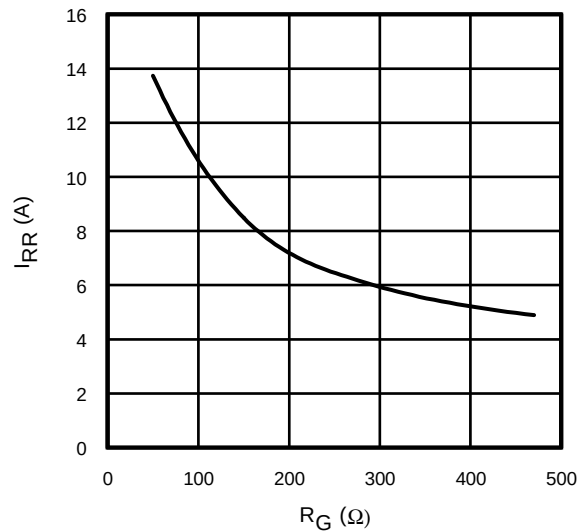


Fig. 18 - Typical Diode I_{RR} vs. R_G
 $T_J = 150^\circ\text{C}; I_F = 10\text{A}$

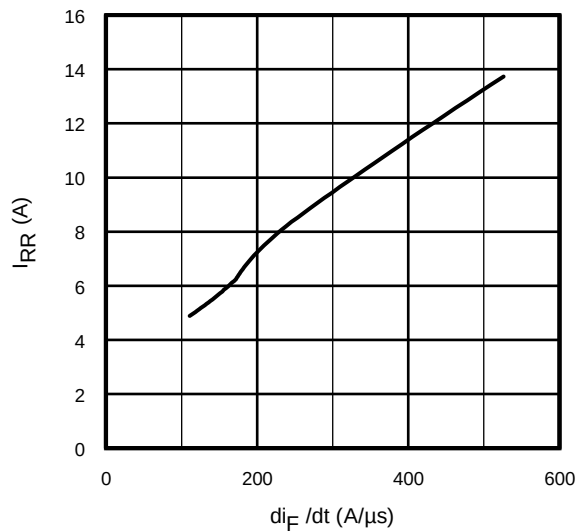


Fig. 19 - Typical Diode I_{RR} vs. di_F/dt
 $V_{CC} = 400\text{V}; V_{GE} = 15\text{V};$
 $I_{CE} = 10\text{A}; T_J = 150^\circ\text{C}$

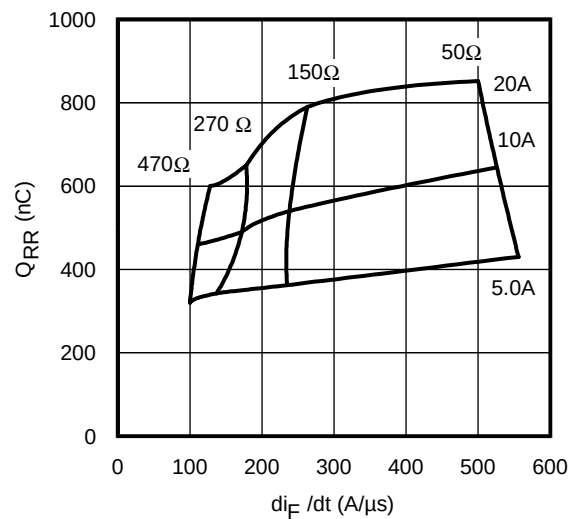


Fig. 20 - Typical Diode Q_{RR}
 $V_{CC} = 400\text{V}; V_{GE} = 15\text{V}; T_J = 150^\circ\text{C}$

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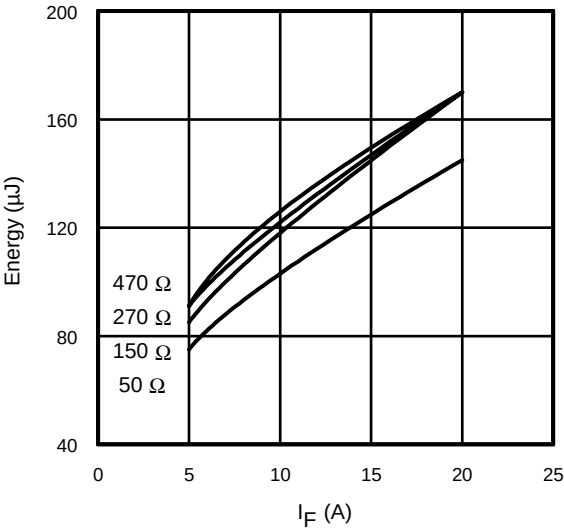


Fig. 21 - Typical Diode E_{RR} vs. I_F
 $T_J = 150^\circ C$

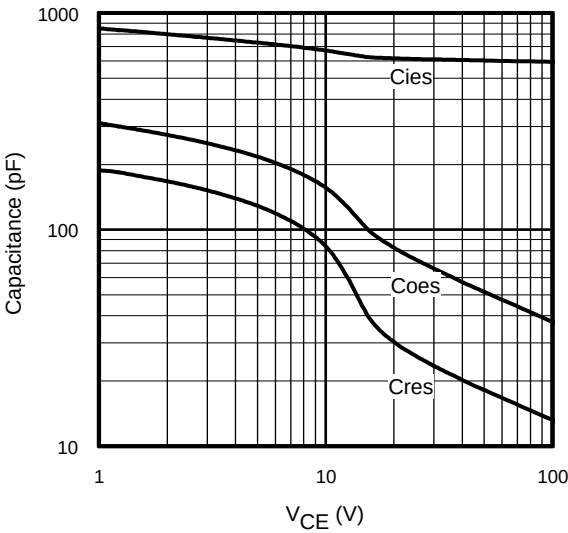


Fig. 22- Typ. Capacitance vs. V_{CE}
 $V_{GE} = 0V$; $f = 1MHz$

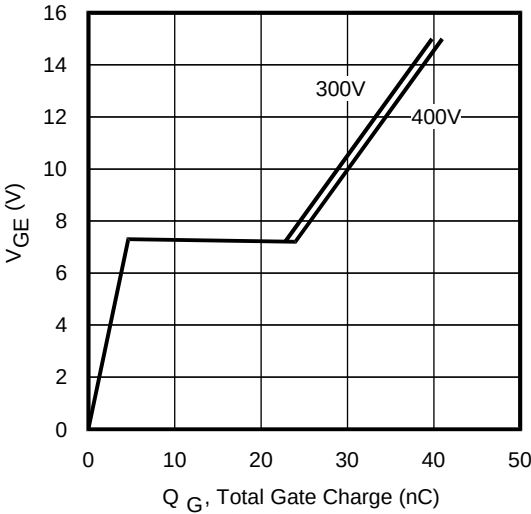


Fig. 23 - Typical Gate Charge vs. V_{GE}
 $I_{CE} = 10A$; $L = 2500\mu H$

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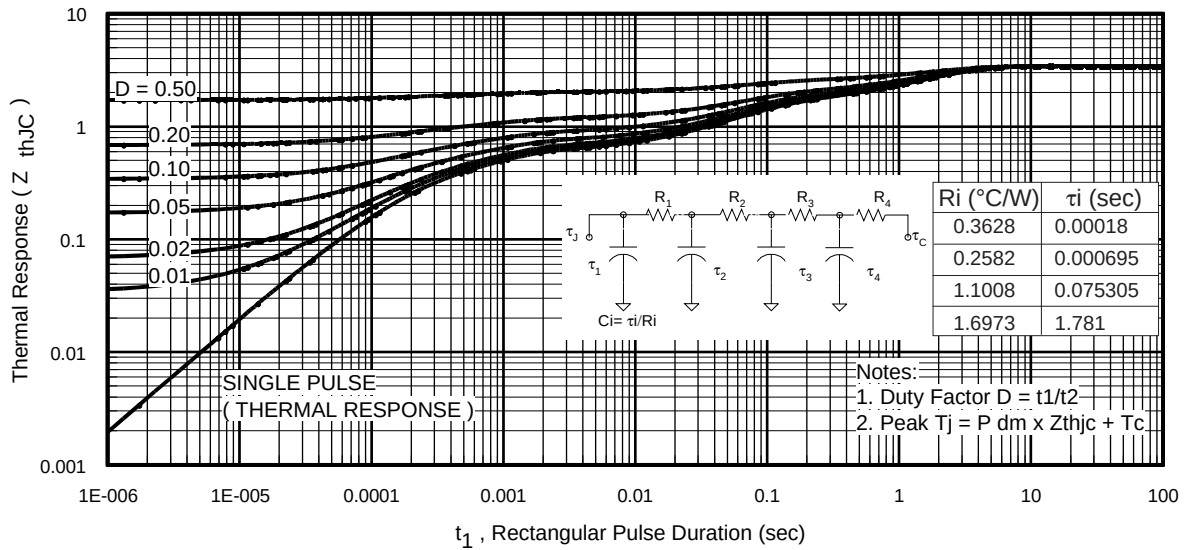


Fig 24. Maximum Transient Thermal Impedance, Junction-to-Case (IGBT)

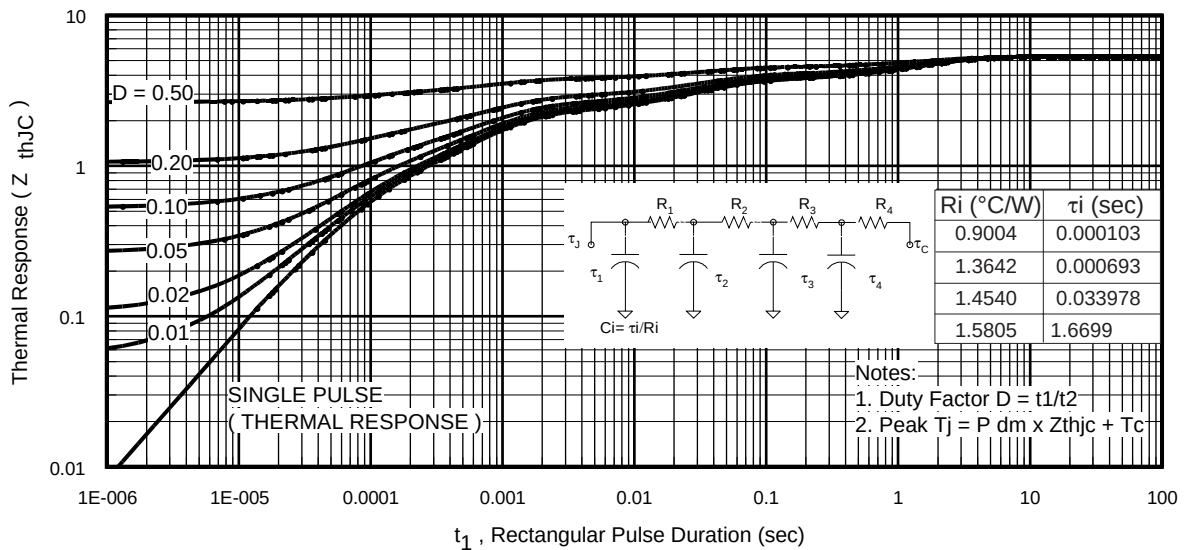


Fig 25. Maximum Transient Thermal Impedance, Junction-to-Case (DIODE)

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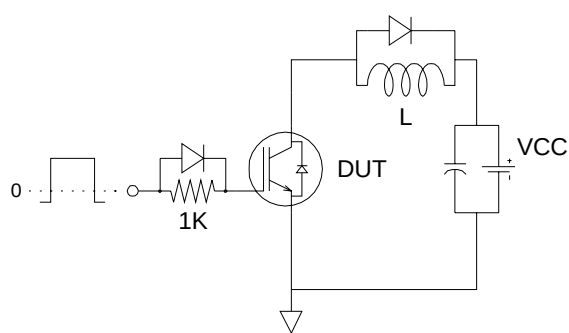


Fig.C.T.1 - Gate Charge Circuit (turn-off)

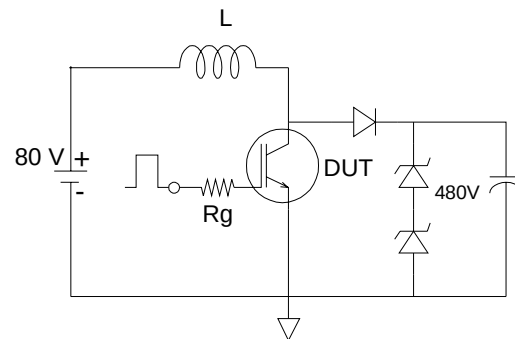


Fig.C.T.2 - RBSOA Circuit

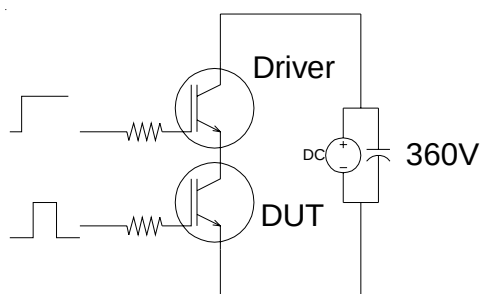


Fig.C.T.3 - S.C.SOA Circuit

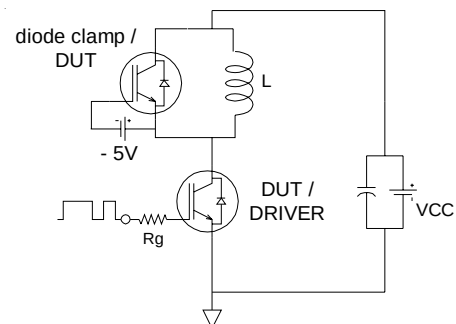


Fig.C.T.4 - Switching Loss Circuit

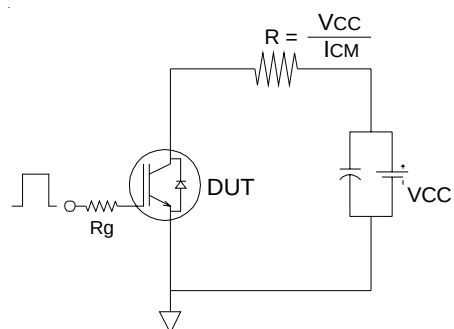


Fig.C.T.5 - Resistive Load Circuit

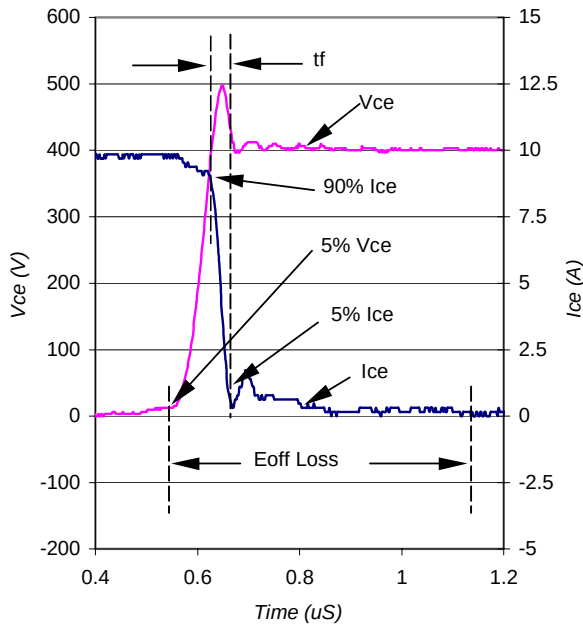


Fig. WF1- Typ. Turn-off Loss Waveform
@ $T_J = 150^{\circ}\text{C}$ using Fig. CT.4

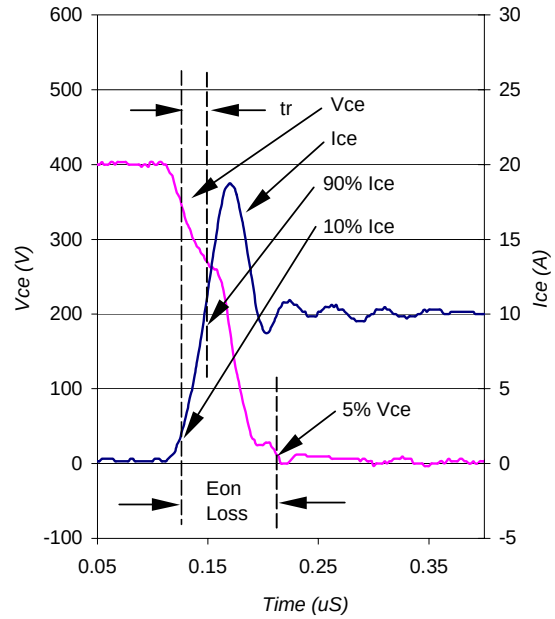


Fig. WF2- Typ. Turn-on Loss Waveform
@ $T_J = 150^{\circ}\text{C}$ using Fig. CT.4

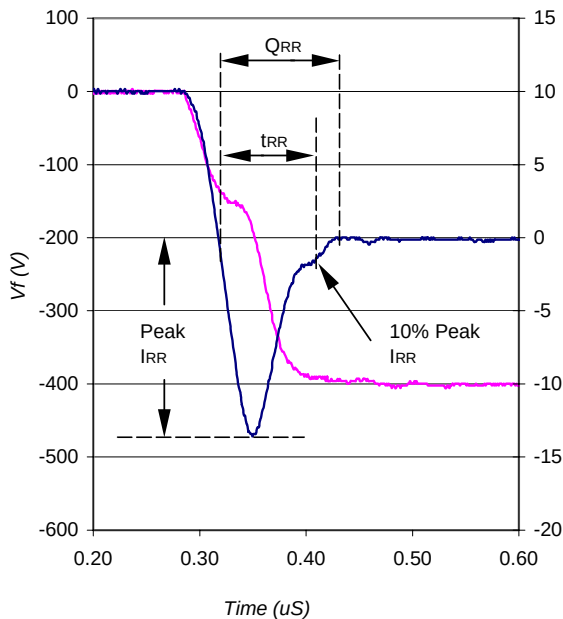


Fig. WF3- Typ. Diode Recovery Waveform
@ $T_J = 150^{\circ}\text{C}$ using Fig. CT.4

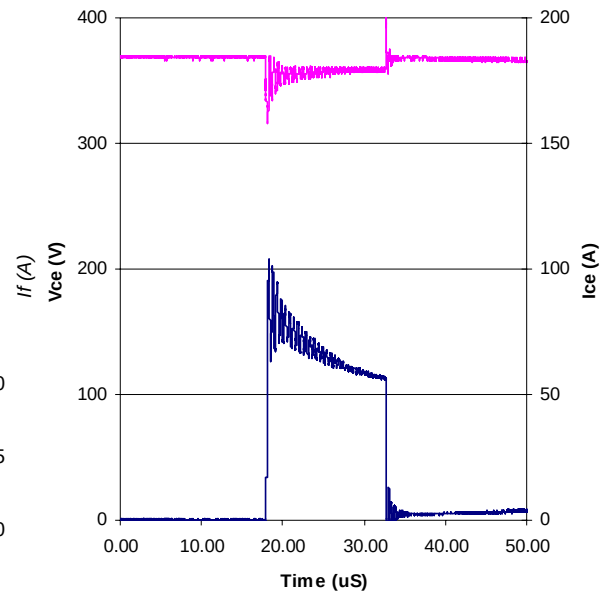


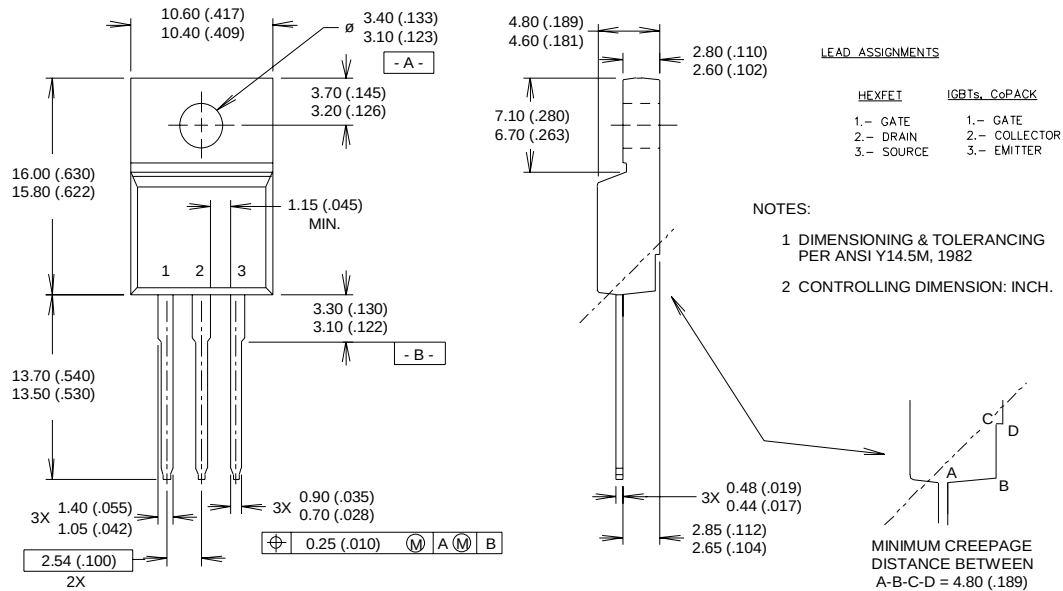
Fig. WF4- Typ. S.C Waveform
@ $T_C = 150^{\circ}\text{C}$ using Fig. CT.3

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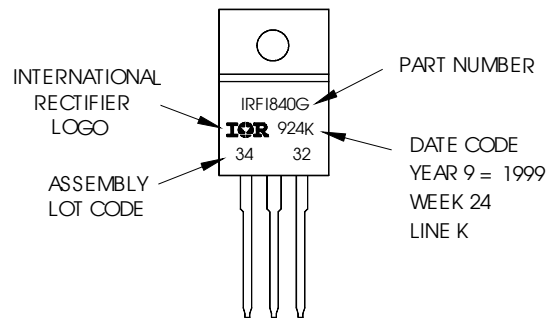
TO-220 Full-Pak Package Outline

Dimensions are shown in millimeters (inches)



TO-220 Full-Pak Part Marking Information

EXAMPLE: THIS IS AN IRF1840G
WITH ASSEMBLY
LOT CODE 3432
ASSEMBLED ON WW 24 1999
IN THE ASSEMBLY LINE "K"



TO-220 Full-Pak package is not recommended for Surface Mount Application

Data and specifications subject to change without notice.
This product has been designed and qualified for the Industrial market.
Qualification Standards can be found on IR's Web site.

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Note: For the most current drawings please refer to the IR website at:
<http://www.irf.com/package/>